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(54) Title: METHOD FOR IMPROVING INTERFACE REACTIONS AT SEMICONDUCTOR SURFACES

(57) Abstract: The present invention describes a method for producing ultra-thin thermally stoichiometric or almost stoichiometric nitrides on semiconductor wafers. The method according to the invention includes the H+- or D+-passivation of the free semiconductor surface, followed by nitriding either in an RTP system, an oven or in plasma. Compounds containing deuterium are preferred in all of the method steps of the invention in order to passivate the interface layer between the silicon surface and the dielectric.

#### INTERNATIONAL SEARCH REPORT

International application No PCT/IB2007/053240

A. CLASSIFICATION OF SUBJECT MATTER INV. H01L21/318 H01L21/314

ADD. H01L21/28

According to International Patent Classification (IPC) onto both national classification and IPC

#### B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols) H01L - C23C

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practical, search terms used)

EPO-Internal, INSPEC

| C. DOCUM  | ENTS CONSIDERED TO BE RELEVANT  |                                      |                  |  |
|---|---|--------------------------------------|------------------|--|
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| * Special categories of cited documents  *A* document defining the general state of the art which is not considered to be of particular relevance  *E* earlier document but published on or after the international filing date  *L* document which may throw doubts on priority claim(s) or which is cited to establish the publication date of another citation or other special reason (as specified)  *O* document referring to an oral disclosure, use, exhibition or other means  *P* document published prior to the international filing date but later than the priority date claimed  *See patent tamily annex.  *T* later document published after the international filing dor or priority date and not in conflict with the application cited to understand the principle or theory underlying invention cannot be considered novel or cannot be considered novel or cannot be considered involve an inventive step when the document is taken to cannot be considered to involve an inventive step when the document is combined with one or more other such document is combined with one or more other such document is combination being obvious to a person sin the art.  *** document member of the same patent family |   |                                      |                  |  |
|   | than the priority date claimed  actual ∞mpletion of the international search  | Date of mailing of the interna       |                  |  |
| ;   | 3 March 2008  | 18/08/2008                           |                  |  |
| Name and  | mailing address of the ISA/ European Patent Office, P.B. 5818 Patentlaan 2 NL - 2280 HV Rijswijk Tel. (+31-70) 340-2040, Tx. 31 651 epo nl. | Authorized officer  Bakker, Jero     |                  |  |

## INTERNATIONAL SEARCH REPORT

International application No
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| A          | US 2005/170666 A1 (SEKINE KATSUYUKI [JP]<br>ET AL) 4 August 2005 (2005-08-04)<br>paragraph [0038] - paragraph [0058];<br>figure 3   | 1-19                  |
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International application No. PCT/IB2007/053240

## **INTERNATIONAL SEARCH REPORT**

| Box No. II Observations where certain claims were found unsearchable (Continuation of item 2 of first sheet)  |
|---|
| This international search report has not been established in respect of certain claims under Article 17(2)(a) for the following reasons:  |
| Claims Nos.: because they relate to subject matter not required to be searched by this Authority, namely:   |
| 2. Claims Nos.:   |
| because they relate to parts of the international application that do not comply with the prescribed requirements to such an extent that no meaningful international search can be carried out, specifically:       |
|   |
| 3. Claims Nos.: because they are dependent claims and are not drafted in accordance with the second and third sentences of Rule 6.4(a).   |
| Box No. III Observations where unity of invention is lacking (Continuation of item 3 of first sheet)  |
| This International Searching Authority found multiple inventions in this international application, as follows:   |
| see additional sheet  |
|   |
| As all required additional search fees were timely paid by the applicant, this international search report covers all searchable claims.  |
| 2. As all searchable claims could be searched without effort justifying an additional fees, this Authority did not invite payment of additional fees.   |
|   |
| 3. As only some of the required additional search fees were timely paid by the applicant, this international search reportcovers only those claims for which fees were paid, specifically claims Nos.:              |
|   |
|   |
| 4. No required additional search fees were timely paid by the applicant. Consequently, this international search report is restricted to the invention first mentioned in the claims; it is covered by claims Nos.: |
| 1-31, 35-45 insofar they depend on claim 31 and 55-57   |
| Remark on Protest  The additional search fees were accompanied by the applicant's protest and, where applicable, the payment of a protest fee.  |
| The additional search/fees were accompanied by the applicant's protest but the applicable protest fee was not paid within the time limit specified in the invitation.   |
| No protest accompanied the payment of additional search fees.   |
|   |

# FURTHER INFORMATION CONTINUED FROM PCT/ISA/ 210

This International Searching Authority found multiple (groups of) inventions in this international application, as follows:

1. claims: 1-31, 35-45 insofar they depend on claim 31 and 55-57

Method for producing silicon nitride layers on semiconductor wafers

2. claims: 46-54, claims 32 to 34 and claims 35 to 45 insofar they depend on 32 to 34  $\,$ 

Controlled thermal treatment to selectively remove the hydrogen from a semiconductor wafer overlaid with deuterium and hydrogen

### INTERNATIONAL SEARCH REPORT

Information on patent family members

International application No PCT/IB2007/053240

| Patent document cited in search report |      | Publication<br>date | Patent family member(s) |                       | Publication date |                          |
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